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RESEARCH & DEVELOPMENT

FE Simulation of Interfacial Delamination between SiO₂ Thin Film and Polymeric Substrate

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- 1. Context
- 2. Experimental study
- 3. Numerical modeling of the test
- 4. Numerical simulation results
- 5. Conclusions and perspectives





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- 3. Numerical modeling of the test
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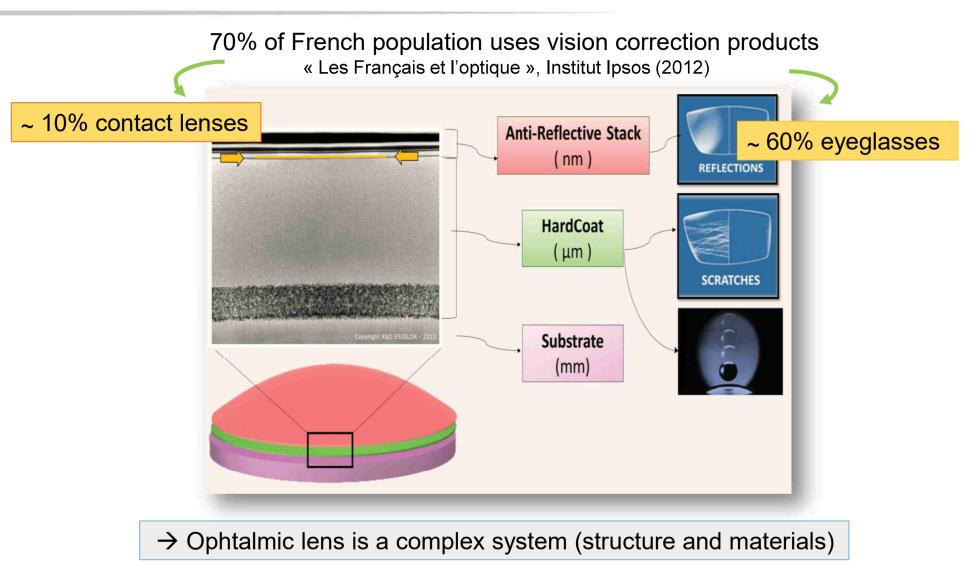


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Context







Context

Challenge

Insufficient adhesion between layers can lead to delamination



→ Important margin of safety prior to product launch

Delamination after Process Modification

Need of a better understanding of mechanisms of adhesion

Simplification of the system: Study of Adhesion of SiO₂ thin film on Hardcoat





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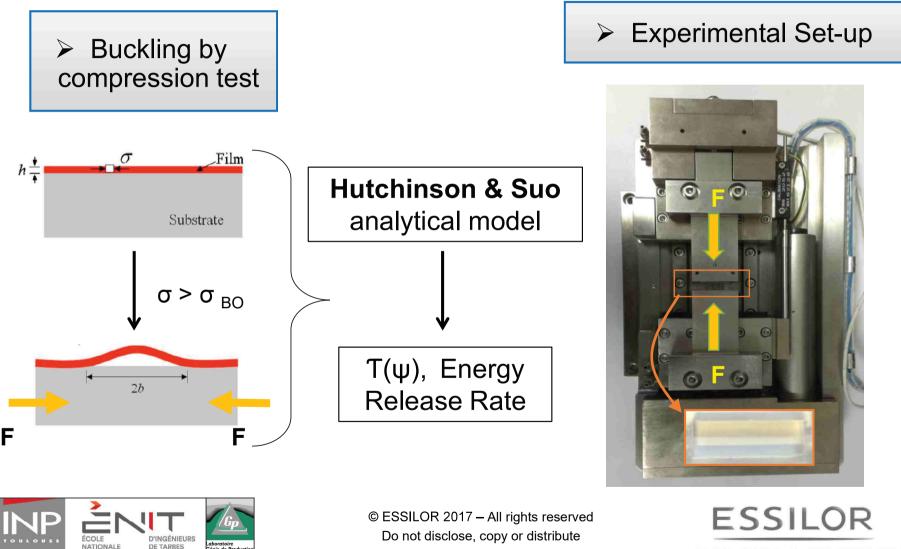


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Adhesion Characterization by compression test



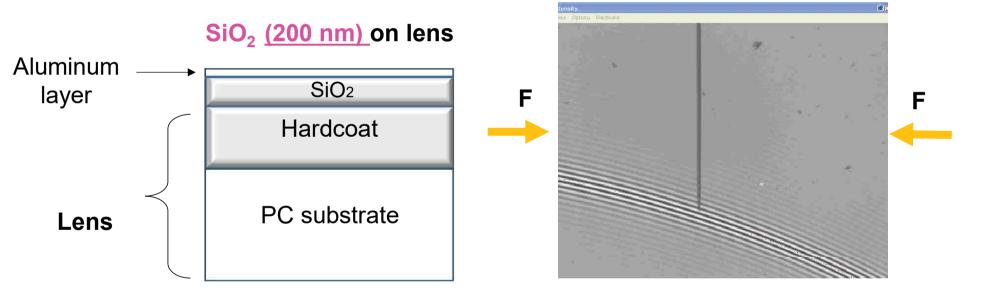
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Experimental results

Configurations of samples

Video of buckling







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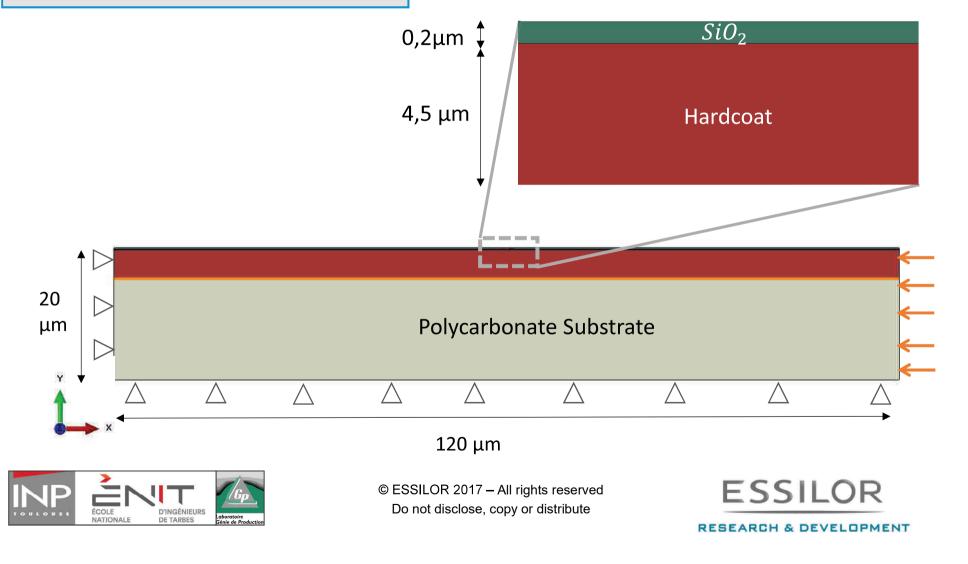
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Description of Numerical model

Geometry | Boundary conditions



Description of Numerical model

Physical model

- Solving the momentum equation : Instability caused by buckling
- Interface degradation using damage model

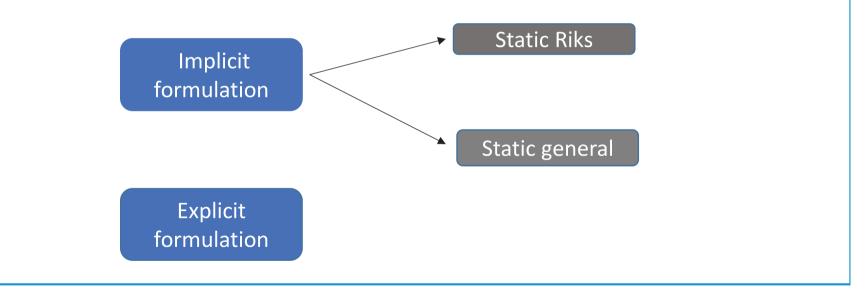




Description of Numerical model

Physical model

• Solving the momentum equation : Instability caused by buckling



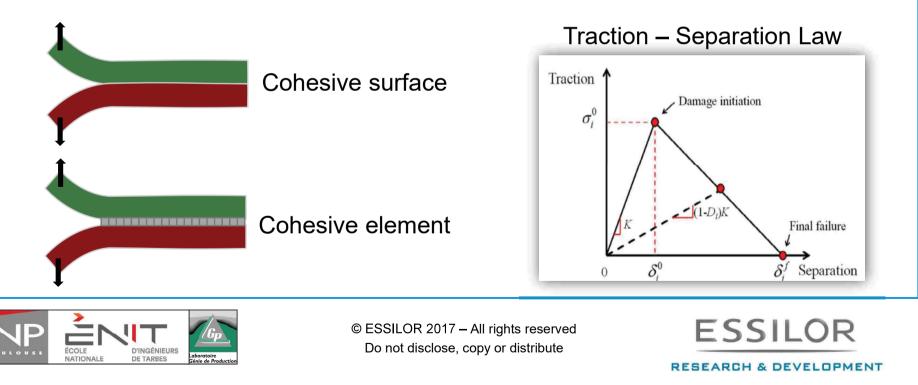


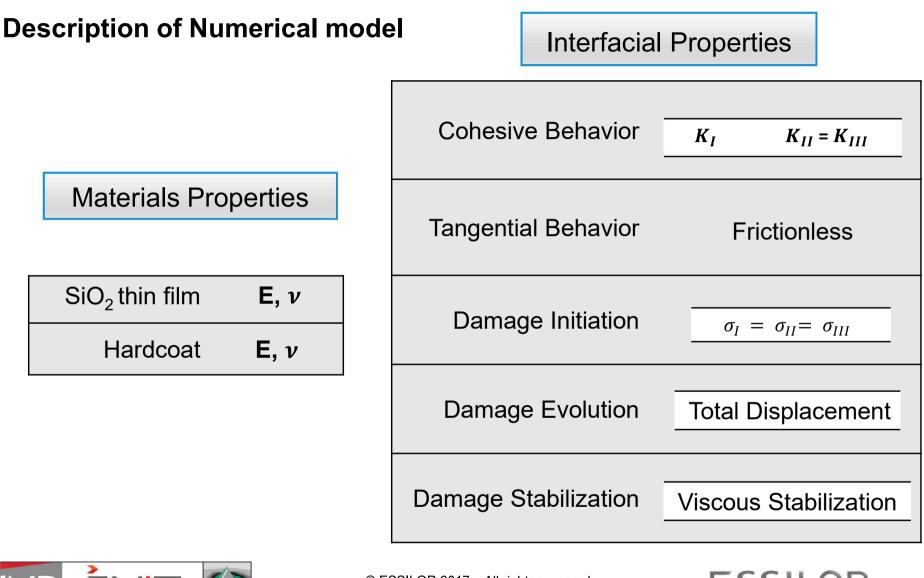


Description of Numerical model

Physical model

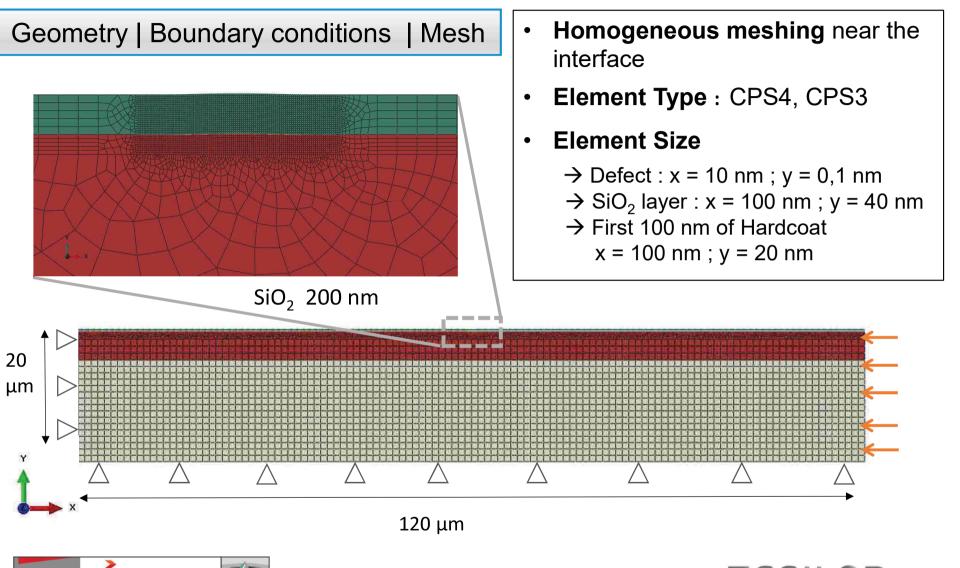
- Solving the momentum equation: Instability caused by buckling
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Numerical simulation results

• Video of simulated buckling

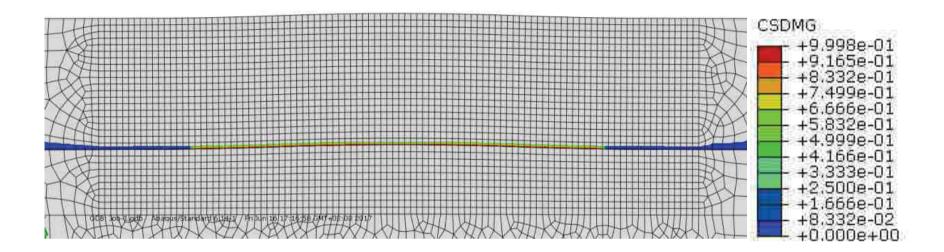






Numerical simulation results

• Interface damage variable CSDMG

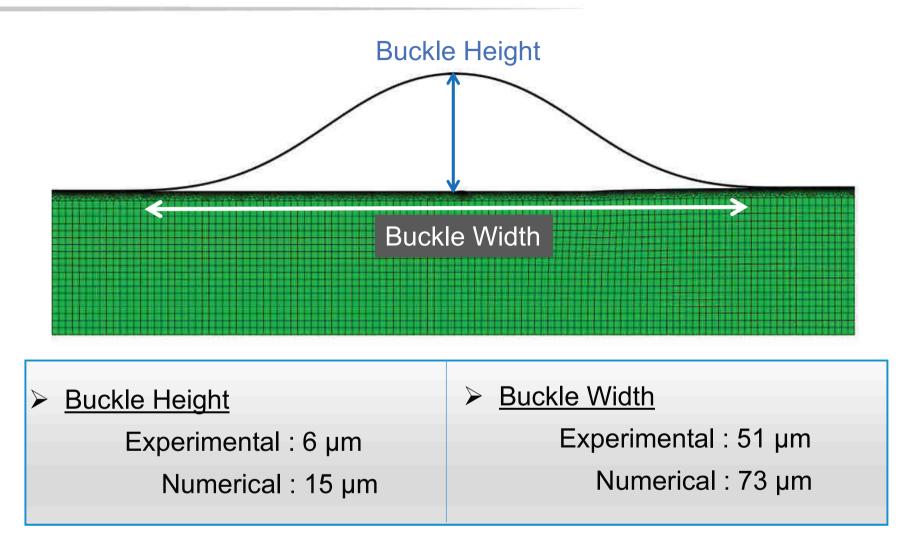


Initiation Strain
 Experimental : 3,8 % strain
 Numerical : 3,9 % strain





Numerical simulation results







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Conclusions

- Model using static calculation with cohesive surface
 → Buckling obtained with numerical model
- Good match of Initiation strain with experimental results
- Buckle dimensions to be improved upon
- Perspectives
 - Parametric study
 - Analysis of energy dissipated





Acknowlegments



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Thank you for your attention



